



SDM10K45

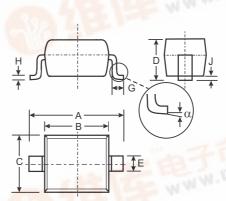
SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: Cathode BandMarking: See Page 2
- Type Code: LG
- Ordering Information: See Below
- Weight: 0.006 grams (approximate)



377	ZSG.	COM			
All ar.	SOD-323				
,	Dim	Min	Max		
	Α	2.30	2.70		
Ţ	В	1.60	1.80		
	С	1.20	1.40		
1	D	1.05 T	05 Typical		
$\frac{1}{4}\alpha$	E	0.25	0.35		
	G	0.20	0.40		
7-1	Н	0.10	0.15		
2 20 0	J	0.05 Typical			
Maria	α	0°	8°		
	All Dimensions in mm				

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} 45		L5G-G0	
RMS Reverse Voltage	V _{R(RMS)}	40	V	
Forward Continuous Current (Note 1)	I _{FM}	100	mA	
Forward Surge Current @ t < 8.3ms	I _{FSM}	1.0	A	
Power Dissipation (Note 1)	P_d	200	mW	
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	500	°C/W	
Operating and Storage Temperature Range	T_j , T_{STG}	-40 to +125	°C	

Electrical Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	45	1		1.4	$I_R = 100 \mu A$
Forward Voltage	V _F	1/2-	370	450	mV	I _F = 10mA
Reverse Leakage Current (Note 2)	IR	W-	0.07	1.0	μА	V _R = 10V
Total Capacitance	Ст	_	6.0	_	pF	V _R = 10V, f = 1.0MHz

Ordering Information (Note 3)

Device	Packaging	Shipping
SDM10K45-7-F	SOD-323	3000/Tape & Reel

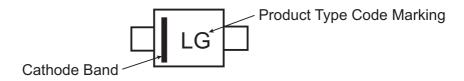
Note: 1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

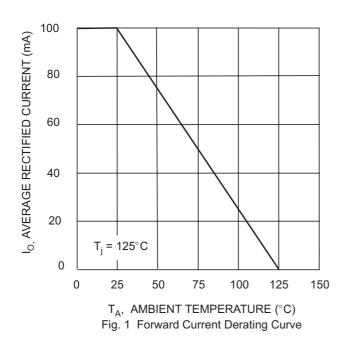
Short duration pulse test to minimize self-heating effect.

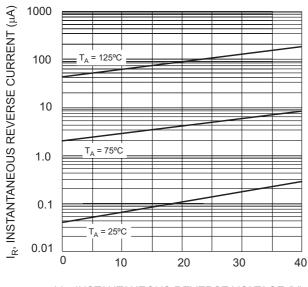
For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. No purposefully added lead.

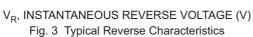


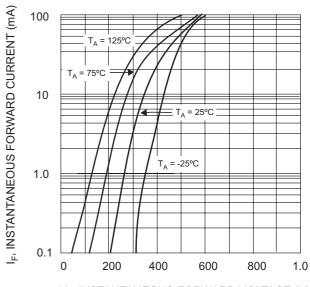
Marking Information











 $\rm V_{\rm F},$ INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics

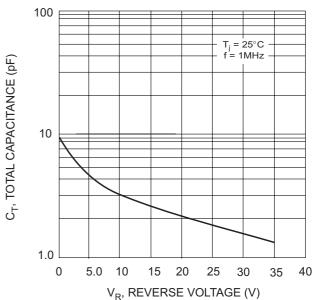


Fig. 4 Total Capacitance vs. Reverse Voltage



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